

-30V P-Channel Mosfet

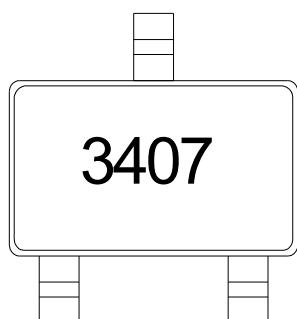
## FEATURES

- $R_{DS(ON)} \leq 60\text{m}\Omega$  (48m $\Omega$  Typ.) @ $V_{GS}=-10\text{V}$
- $R_{DS(ON)} \leq 85\text{m}\Omega$  (62m $\Omega$  Typ.) @ $V_{GS}=-4.5\text{V}$

## APPLICATIONS

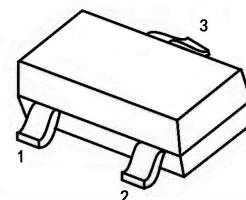
- Load Switch
- Power Management

## MARKING



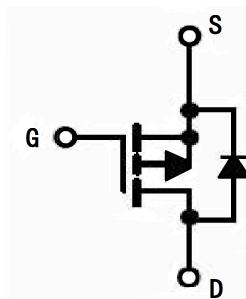
3407: Device code

## SOT-23



1. GATE
2. SOURCE
3. DRAIN

## P-CHANNEL MOSFET



## MAXIMUM RATINGS (Ta=25°C unless otherwise noted)

Symbol	Parameter	Max.	Units
$V_{DSS}$	Drain-Source Voltage	-30	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current	-4.1	A
$I_{DM}$	Pulsed Drain Current <sup>note1</sup>	-16.4	A
$P_{tot}$	Total Power Dissipation	1.67	W
$R_{eJA}$	Thermal Resistance, Junction to Ambient	75	°C/W
$T_J$	Junction Temperature	150	°C
$T_{STG}$	Storage Temperature Range	-55 to +150	°C

**MOSFET ELECTRICAL CHARACTERISTICS Ta=25 °C unless otherwise specified**

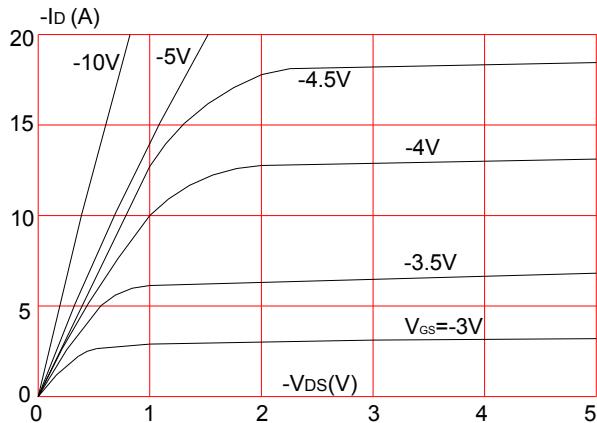
Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristics</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-30	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 25°C	-	-	-1	μA
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V	-	-	±100	nA
<b>On Characteristics</b>						
V <sub>G(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-1.0	-1.4	-2.5	V
R <sub>D(on)</sub>	Static Drain-Source On-Resistance <sup>note2</sup>	V <sub>GS</sub> = -10V, I <sub>D</sub> = -4.1A	-	48	60	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -3.5A	-	62	85	
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = -5V, I <sub>D</sub> = -4.1A	5	-	-	S
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V f = 1.0MHz	-	580	-	pF
C <sub>oss</sub>	Output Capacitance		-	98	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	74	-	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = -15V, I <sub>D</sub> = -4.1A, V <sub>GS</sub> = -10V	-	6.8	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	1.0	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge		-	1.4	-	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -15V R <sub>G</sub> = 2.5Ω, I <sub>D</sub> = -1A R <sub>L</sub> = 15Ω,	-	14	-	ns
t <sub>r</sub>	Turn-On Rise Time		-	61	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	19	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	10	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>s</sub>	Maximum Continuous Drain to Source Diode Forward Current		-	-	-4.1	A
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-16.4	A
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>SD</sub> = -4.1A T <sub>J</sub> = 25°C	-	-0.89	-1.2	V

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

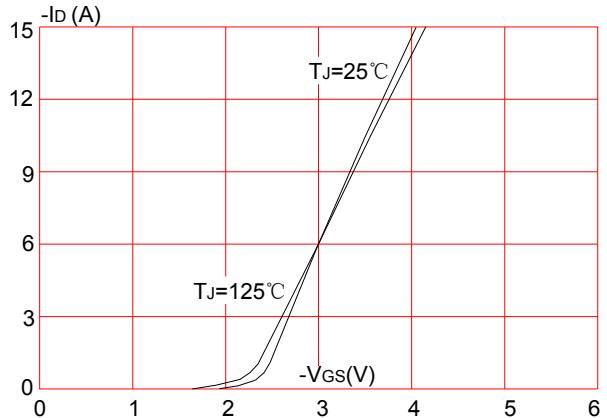
2 . Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 2%

## TYPICAL PERFORMANCE CHARACTERISTICS

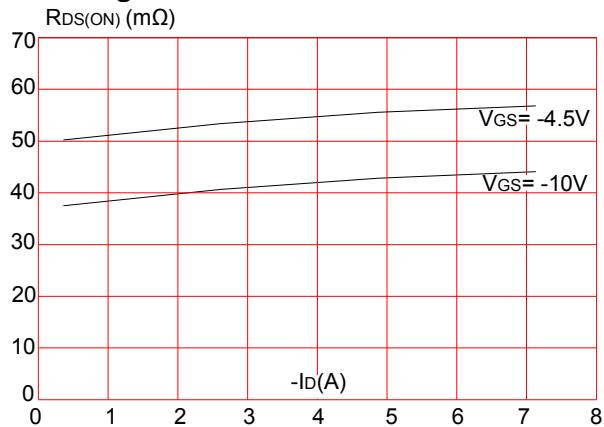
**Figure 1:** Output Characteristics



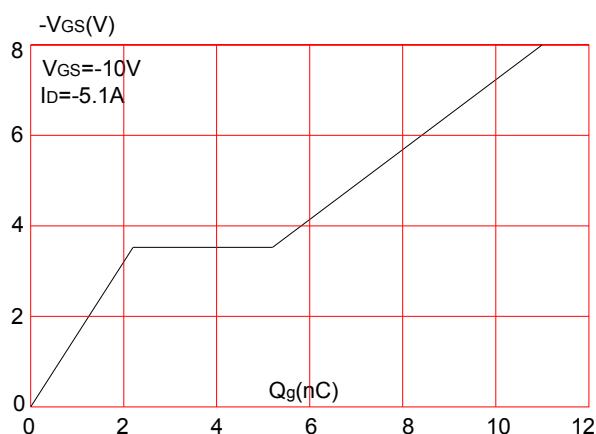
**Figure 2:** Typical Transfer Characteristics



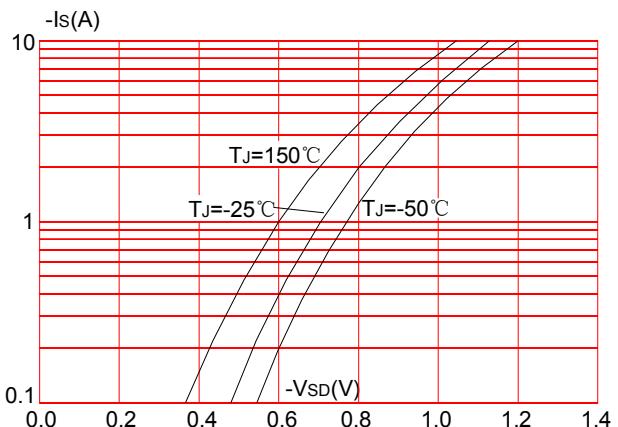
**Figure 3:** On-resistance vs. Drain Current



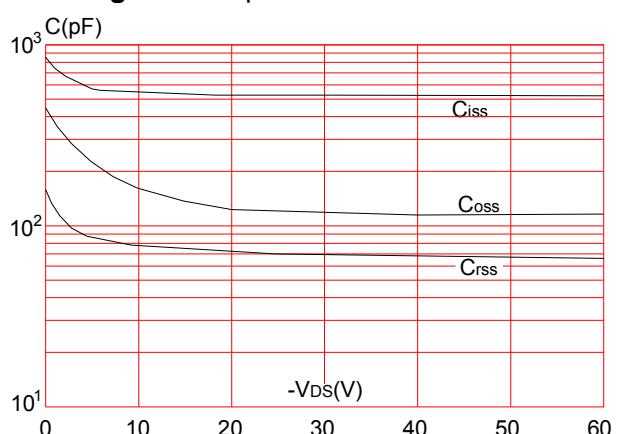
**Figure 5:** Gate Charge Characteristics



**Figure 4:** Body Diode Characteristics

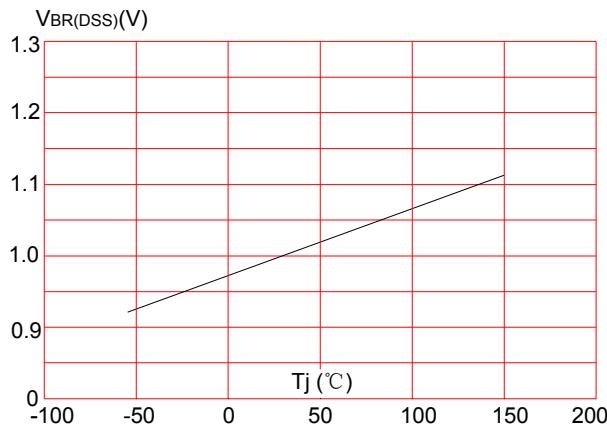


**Figure 6:** Capacitance Characteristics

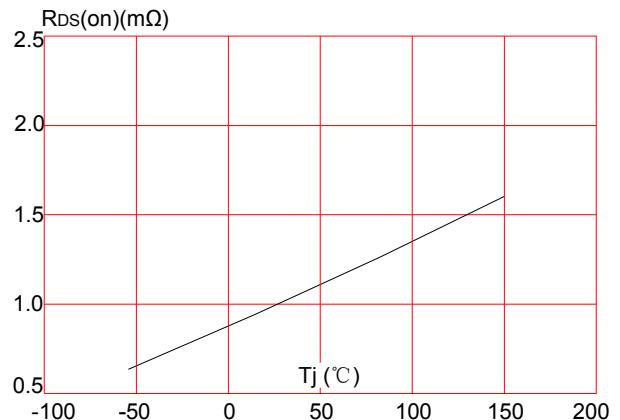


## TYPICAL PERFORMANCE CHARACTERISTICS (cont.)

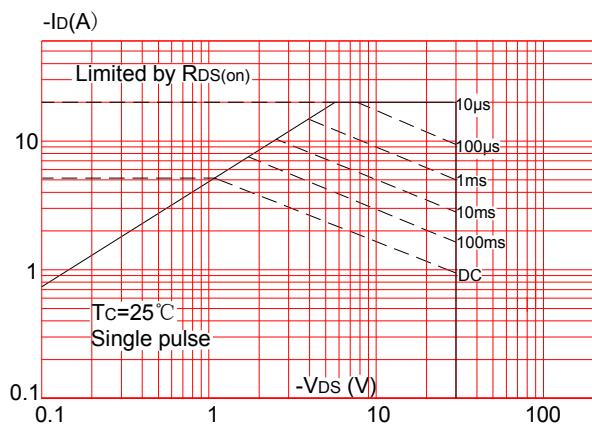
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



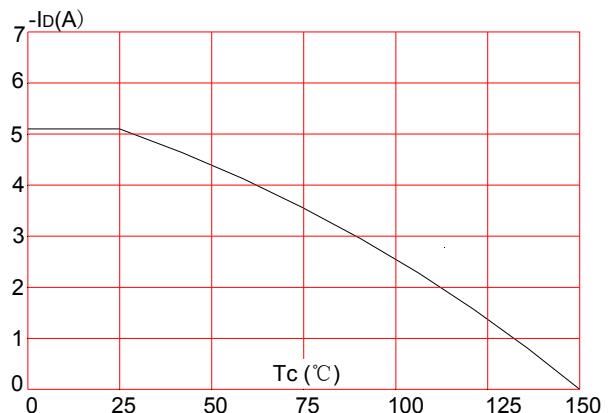
**Figure 8:** Normalized on Resistance vs. Junction Temperature



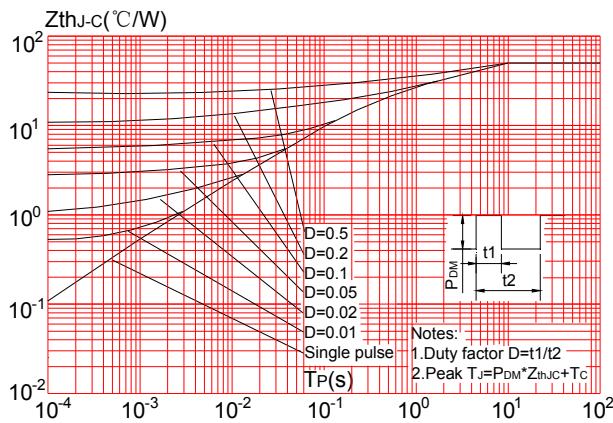
**Figure 9:** Maximum Safe Operating Area



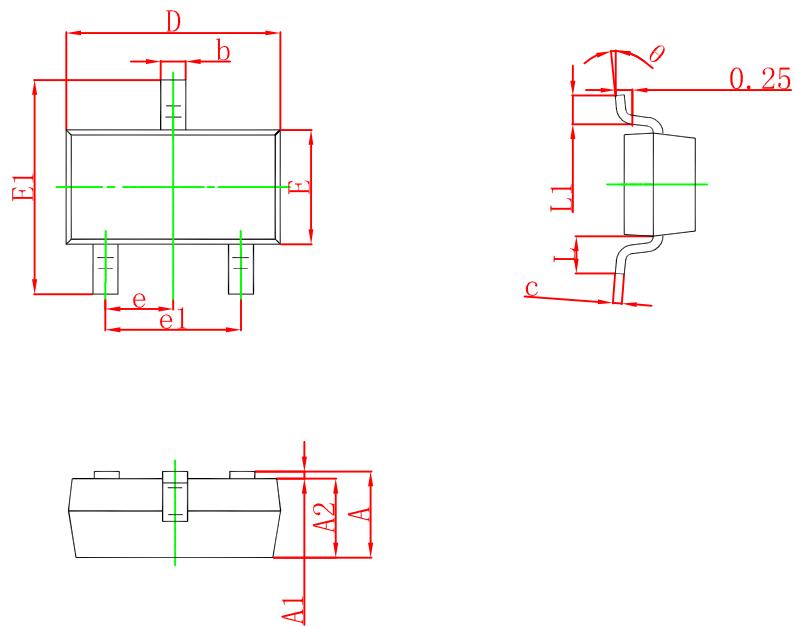
**Figure 10:** Maximum Continuous Drain Current vs. Case Temperature



**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient (SOP-8)



## SOT-23 PACKAGE OUTLINE DRAWING



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

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